

STGP35HF60W

35 A, 600 V Ultrafast IGBT

Datasheet - production data

Features

- Improved E_{off} at elevated temperature
- Minimal tail current
- Low conduction losses

Applications

- Welding
- High frequency converters
- Power factor correction

Description

This Ultrafast IGBT is developed using a new planar technology to yield a device with tighter switching energy variation (E_{off}) versus temperature. The suffix "W" denotes a subset of products designed for high switching frequency operation (over 100 kHz).

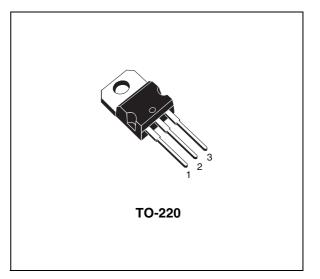


Figure 1. Internal schematic diagram

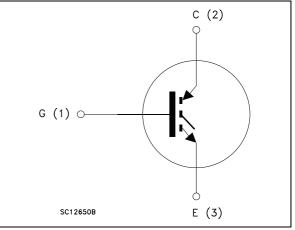


Table 1. Device summary

Order codes	Markings	Packages	Packaging
STGP35HF60W	GP35HF60W	TO-220	Tube

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November 2012
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Doc ID 023894 Rev 1

This is information on a product in full production.

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1 Electrical ratings

Table 2.	Absolute	maximum	ratings
	/10001010	maximani	racingo

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Continuous collector current at $T_C = 25 \ ^{\circ}C$	60	А
$I_{C}^{(1)}$	Continuous collector current at $T_c = 100 \text{ °C}$	35	А
$I_{CP}^{(2)}$	Pulsed collector current	150	А
I _{CL} ⁽³⁾	Turn-off latching current	80	А
V_{GE}	Gate-emitter voltage	± 20	V
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	200	W
T _{stg}	Storage temperature	– 55 to 150	°C
Тj	Operating junction temperature	- 55 10 150	

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

2. Pulse width limited by maximum junction temperature and turn-off within RBSOA

3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_G = 10 $\Omega,$ T_J = 150 $^{\circ}\text{C}$

Symbol Parameter		Value	Unit
R _{thj-case}	Thermal resistance junction-case IGBT	0.63	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W



2 Electrical characteristics

 $T_J = 25 \ ^{\circ}C$ unless otherwise specified)

Table 4.	Static
	Juano

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
Maria	Collector-emitter	V _{GE} = 15 V, I _C = 20 A			2.5	v
V _{CE(sat)}	saturation voltage	$V_{GE} = 15V, I_{C} = 20 \text{ A}, T_{J} = 125 \text{ °C}$		1.65		v
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1 \text{ mA}$	3.75		5.75	V
I _{CES}	Collector cut-off current	V _{CE} = 600 V			250	μA
'CES	(V _{GE} = 0)	V _{CE} = 600 V, T _J = 125 °C			1	mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			± 100	nA

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0	-	2400 235 50	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 400 \text{ V}, I_{C} = 20 \text{ A},$ $V_{GE} = 15 \text{ V},$ <i>(see Figure 16)</i>	-	140 13 52	-	nC nC nC



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 400 \text{ V}, I_C = 20 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ (see Figure 15)	-	30 15 1650	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 400 \text{ V}, I_C = 20 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_J = 125 \text{ °C} (see Figure 15)$	-	30 15 1600	-	ns ns A/µs
t _r (V _{off}) t _{d(off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V}$ (see Figure 15)	-	30 175 40	-	ns ns ns
$t_r(V_{off}) \ t_d(_{off}) \ t_f$	Off voltage rise time Turn-off delay time Current fall time	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 400 \; V, \; I_{C} = 20 \; A, \\ R_{GE} = 10 \; \Omega, \; V_{GE} = 15 \; V, \\ T_{J} = 125 \; ^{\circ}C \\ \textit{(see Figure 15)} \end{array}$	-	50 225 70	-	ns ns ns

 Table 6.
 Switching on/off (inductive load)

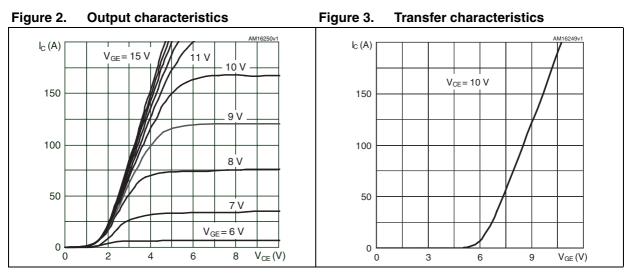
Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾	Turn-on switching losses	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A}$		290		μJ
E _{off}	Turn-off switching losses	$R_{G} = 10 \Omega$, $V_{GE} = 15 V$,	-	185		μJ
E _{ts}	Total switching losses	(see Figure 17)		475		μJ
E _{on} ⁽¹⁾	Turn-on switching losses	$V_{CC} = 400 \text{ V}, I_{C} = 20 \text{ A}$		420		μJ
E _{off}	Turn-off switching losses	R_{G} = 10 Ω, V_{GE} = 15 V,	-	350	530	μJ
E _{ts}	Total switching losses	T _J = 125 °C <i>(see Figure 17)</i>		770		μJ

1. Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 17*. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs and diode are at the same temperature (25 °C and 125 °C). Eon include diode recovery energy.



Electrical characteristics (curves) 2.1





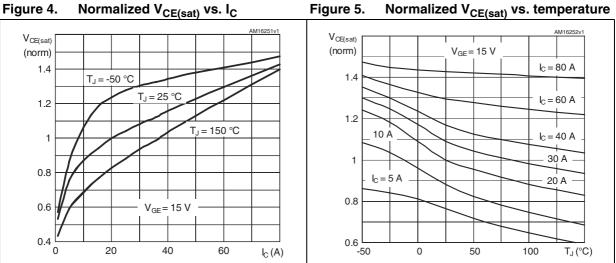
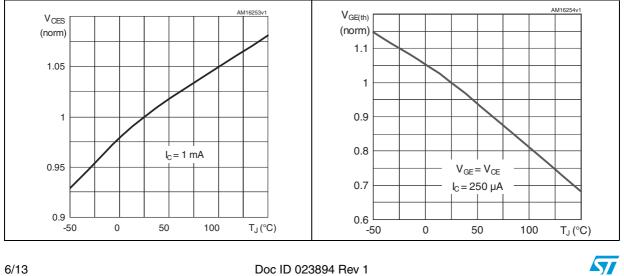


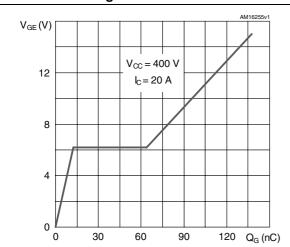
Figure 5.

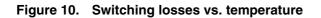
Figure 6. Normalized breakdown voltage vs. Figure 7. Normalized gate threshold voltage vs. temperature temperature



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Figure 8. Gate charge vs. gate-emitter voltage





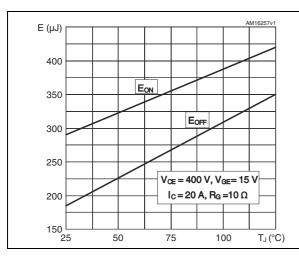


Figure 12. Switching losses vs. collector current

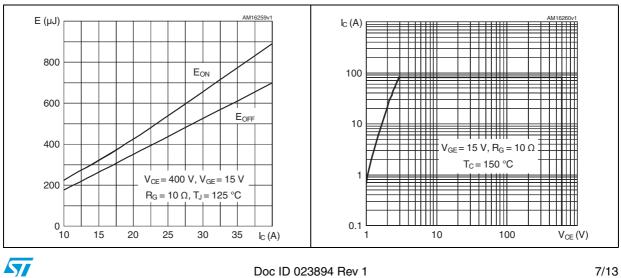
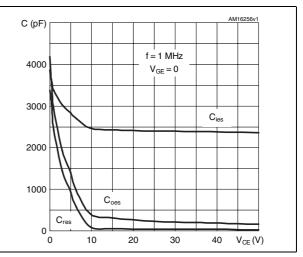
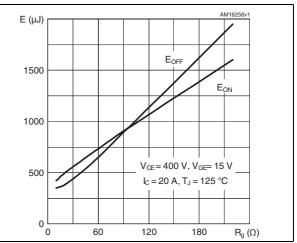


Figure 9. **Capacitance variations**



Switching losses vs. gate Figure 11. resistance



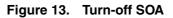
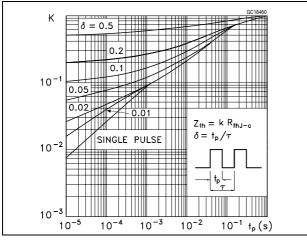


Figure 14. Thermal impedance





3 Test circuits

_____ cc δA ۰A С 12V 47ΚΩ E L=100µH 1KΩ G =100nF 3.3 1000 ုB E μ F μ F $V_{\rm CC}$ I_G=CONST C $V_i = 20V = V_{GMAX}$ 1KΩ С.U.Т. G | 👗 D.U.T. \sim 2200 #F V G __0 2.7KΩ Ε R _G ø 47K Ω 1KΩ . Pw AM01504v1 AM01505v1

Figure 16. Gate charge test circuit

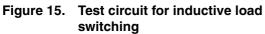
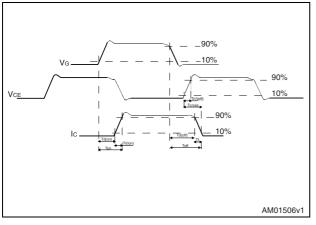


Figure 17. Switching waveform



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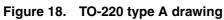
4 Package mechanical data

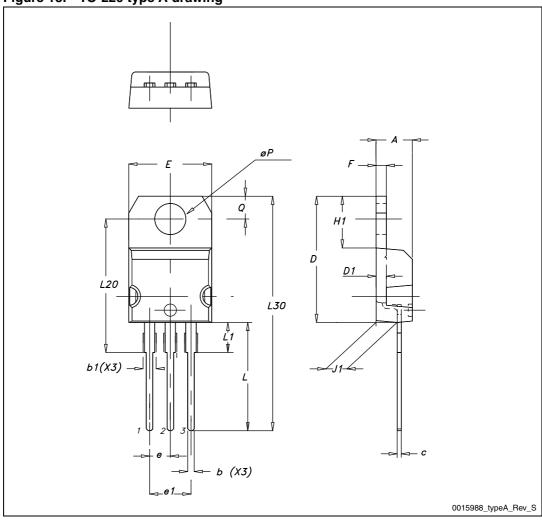
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Dim		mm	
Dim. —	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
с	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
Øр	3.75		3.85
Q	2.65		2.95

Table 8. TO-220 type A mechanical data









5 Revision history

Table 9.Document revision history

Date	Revision	Changes
06-Nov-2012	1	Initial release.



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